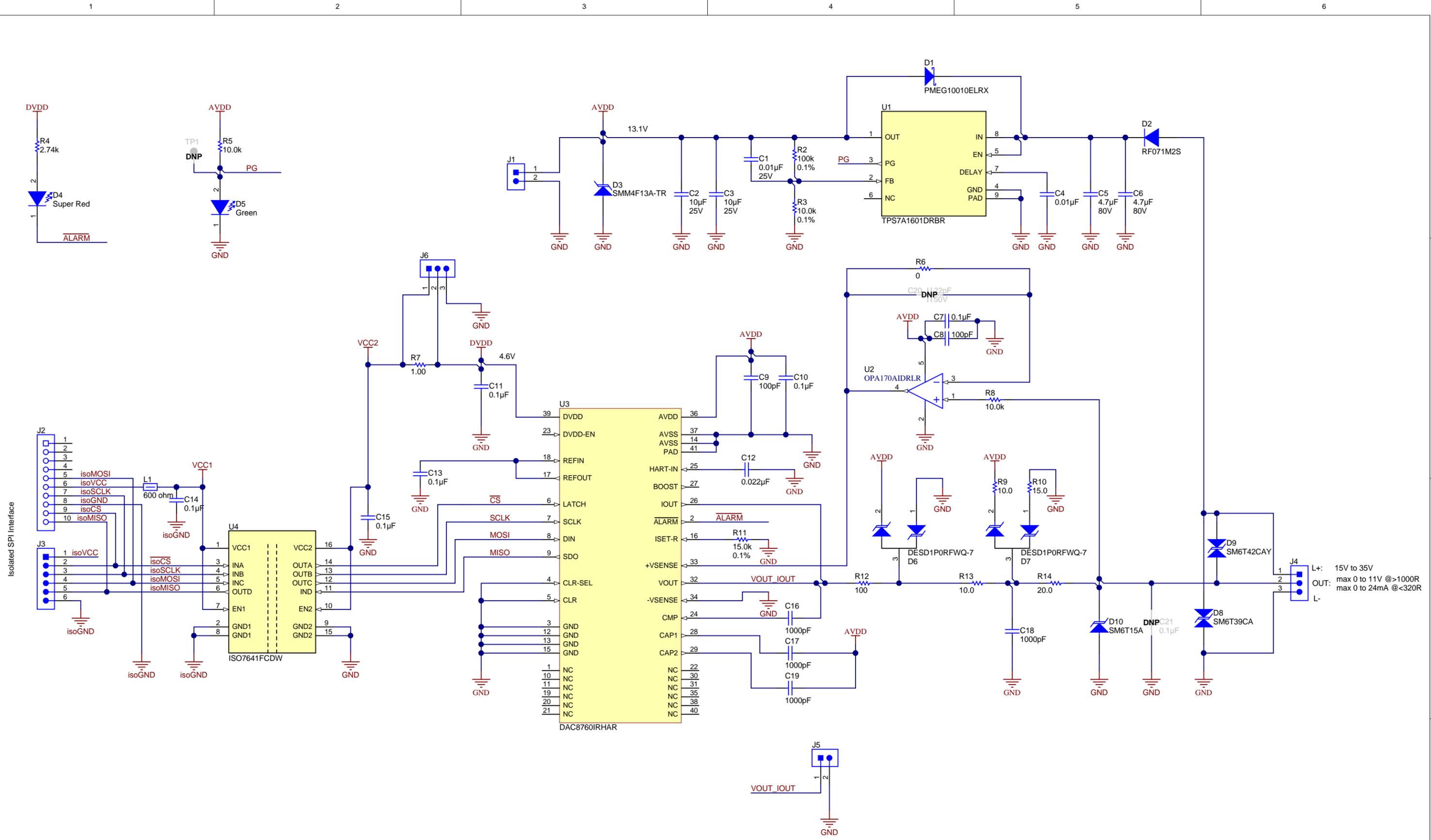


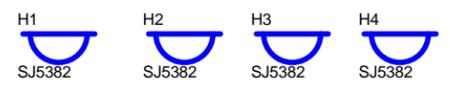
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Orderable: ISFA-EVM-00559	Designed for: Public Release	Mod. Date: 3/15/2016
TID #: TIDA-00559	Project Title: Combined Voltage & Current Output with Protection	
Number: TIDA-00559	Rev: E1	Sheet Title: Combined V/I with protection
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 2 of 3
Drawn By: AW	File: TIDA-00559E1_DAC8760.SchDoc	Size: B
Engineer: JS	Contact: http://www.ti.com/support	TEXAS INSTRUMENTS

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PCB Number: TIDA-00559
PCB Rev: E1

PCB LOGO
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PCB LOGO
Pb-Free Symbol

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ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.

Orderable: ISFA-EVM-00559	Designed for: Public Release	Mod. Date: 3/15/2016	 http://www.ti.com © Texas Instruments 2016
TID #: TIDA-00559	Project Title: Combined Voltage & Current Output with Protection		
Number: TIDA-00559	Rev: E1	Sheet Title: Hardware	
SVN Rev: Version control disabled	Assembly Variant: 001	Sheet: 3 of 3	
Drawn By: AW	File: TIDA-00559E1_EVM_Hardware.SchDoc		Size: B
Engineer: JS	Contact: http://www.ti.com/support		

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